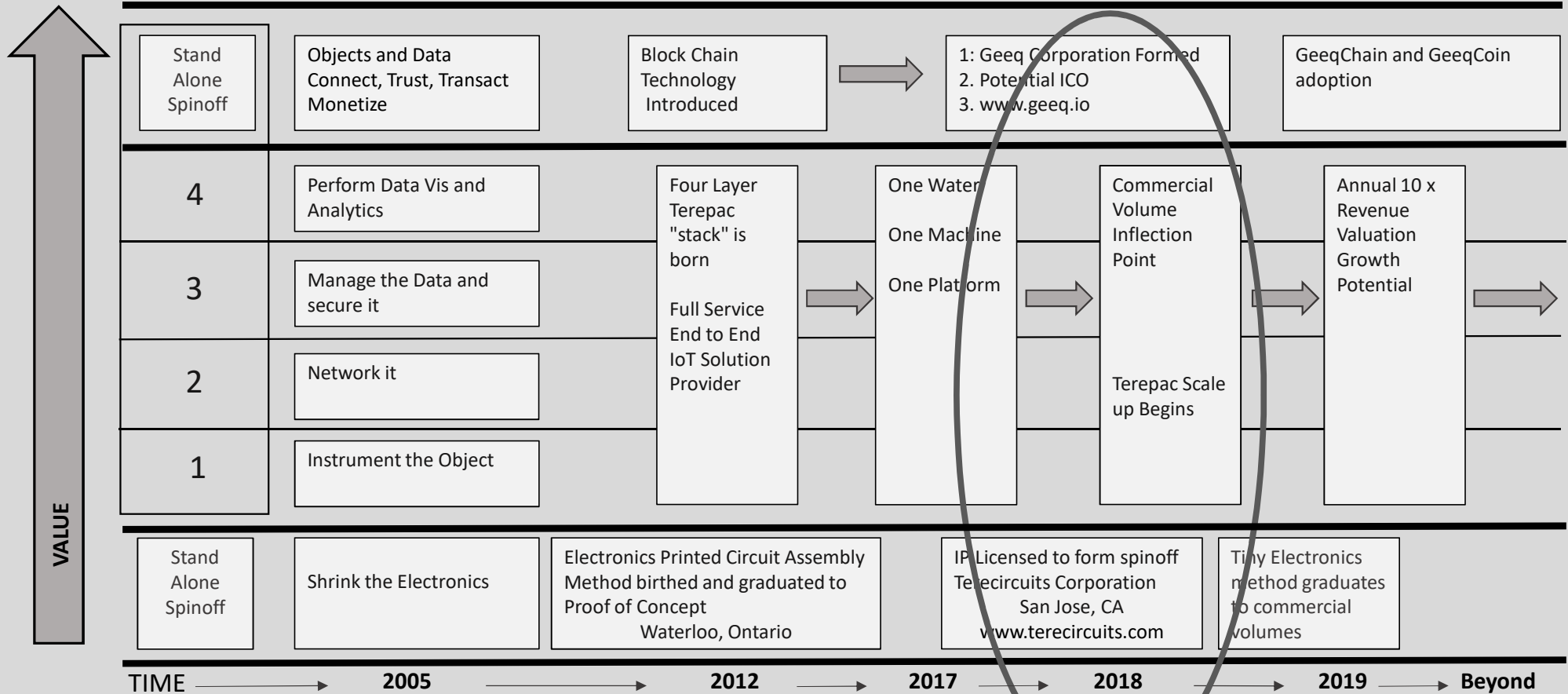# Terepac Corporation …. Giving Voice to the world®

Smart City, Energy, Manufacturing, Retail, Logistics, Verticals Disintegrated.
Host object and vertical agnostic. Any Object. Any Data. At Home. At Work. At Play.

Stack Layer

VALUE ↑

Stack Layer		2005	2012	2017	2018	2019	Beyond
Stand Alone Spinoff		Objects and Data Connect, Trust, Transact Monetize	Block Chain Technology Introduced	→	1: Geeq Corporation Formed 2. Potential ICO 3. www.geeq.io		GeeqChain and GeeqCoin adoption
4		Perform Data Vis and Analytics	Four Layer Terepac "stack" is born	One Water	Commercial Volume Inflection Point	Annual 10 x Revenue Valuation Growth Potential	
3		Manage the Data and secure it	Full Service End to End IoT Solution Provider	One Machine One Platform			
2		Network it			Terepac Scale up Begins		
1		Instrument the Object					
Stand Alone Spinoff		Shrink the Electronics	Electronics Printed Circuit Assembly Method birthed and graduated to Proof of Concept Waterloo, Ontario	IP Licensed to form spinoff Terecircuits Corporation San Jose, CA www.terecircuits.com		Tiny Electronics method graduates to commercial volumes	

TIME → **2005** → **2012** → **2017** → **2018** → **2019** → **Beyond**

NOW

Trajectory Informed and Reflective of:
i) Exponential Organization, Ismail et al. ii) Blueprint to a Billion, Thomson iii) Porter HBR notes, starting November 2014

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